

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
878	FDMA8878	MicroFET 2x2	7 "	8 mm	3000 units

FAIRCHILD

1

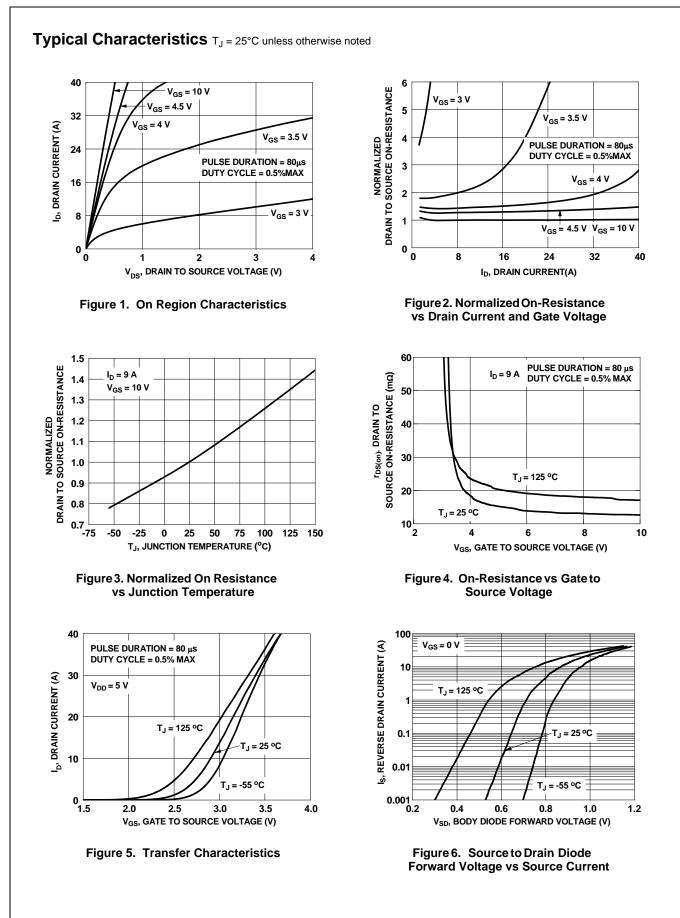
FDMA8878 Single N-Channel
Power
ň®
MOSFET

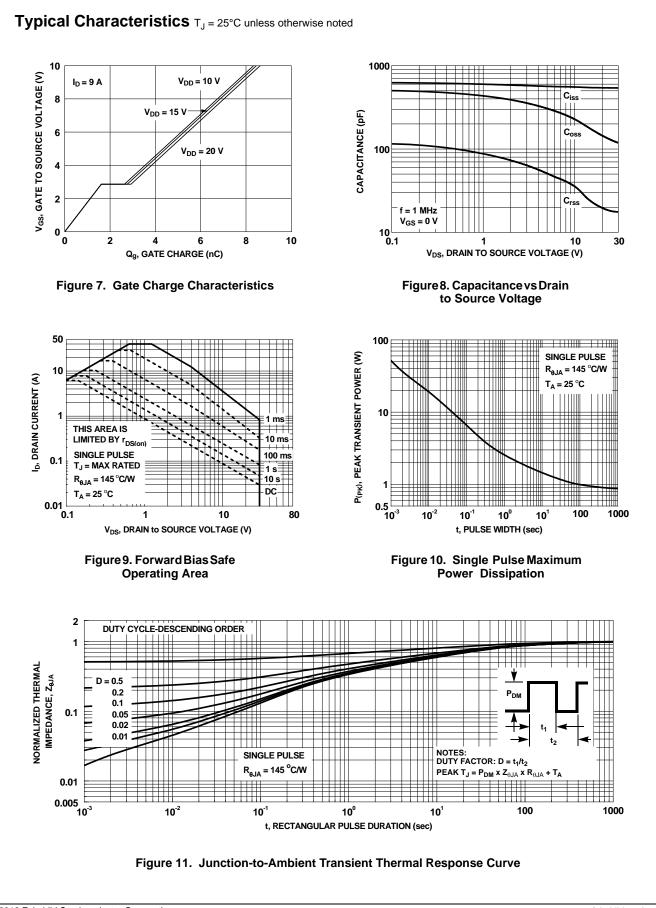
teristics Drain to Source Breakdown Voltage			Тур	Max	
0					
0	I _D = 250 μA, V _{GS} = 0 V	30			V
Breakdown Voltage Temperature					
Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		26		mV/°C
Zero Gate Voltage Drain Current	rain Current $V_{DS} = 24 V, V_{GS} = 0 V$			1	μA
Gate to Source Leakage Current, Forward $V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
teristics					
	$V_{GS} = V_{DS}$, $I_{D} = 250 \ \mu A$	1.2	1.8	3.0	V
Gate to Source Threshold Voltage			_		
Temperature Coefficient	$I_D = 250 \ \mu A$, referenced to 25 °C		-5		mV/°C
	V _{GS} = 10 V, I _D = 9.0 A		13	16	
Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 8.5 \text{ A}$		16	19	mΩ
	V_{GS} = 10 V, I _D = 9.0 A, T _J = 125 °C		17	21	
Forward Transconductance	V _{DD} = 5 V, I _D = 9.0 A		41		S
haractoristics					
			539	720	pF
	$V_{DS} = 15 V, V_{GS} = 0 V,$			-	pF
	f = 1 MHz				pF
				00	Ω
Characteristics Turn-On Delay Time			6	12	ns
Rise Time	V _{DD} = 15 V, I _D = 9.0 A,		2	10	ns
Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		14	25	ns
Fall Time			2	10	ns
Total Gate Charge	$V_{GS} = 0 V$ to 10 V		8.5	12	nC
Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 15 \text{ V}$		4.1	5.8	nC
Total Gate Charge	I _D = 9.0 A		1.6		nC
Gate to Drain "Miller" Charge			1.2		nC
ce Diode Characteristics					
	$V_{cc} = 0 V I_c = 2 0 A$ (Note 2)		0.75	12	
Source to Drain Diode Forward Voltage					V
Reverse Recovery Time			16	28	ns
Reverse Recovery Charge	I _F = 9.0 A, di/dt = 100 A/μs		4	10	nC
	teristics Gate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient Static Drain to Source On Resistance Forward Transconductance haracteristics Input Capacitance Output Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Drain "Miller" Charge Ce Diode Characteristics Source to Drain Diode Forward Voltage Reverse Recovery Time	teristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$ Gate to Source Threshold Voltage $I_D = 250 \ \mu A$, referenced to 25 °CTemperature Coefficient $V_{GS} = 10 \ V$, $I_D = 9.0 \ A$ Static Drain to Source On Resistance $V_{GS} = 10 \ V$, $I_D = 9.0 \ A$ Static Drain to Source On Resistance $V_{GS} = 10 \ V$, $I_D = 9.0 \ A$, $T_J = 125 \ ^{\circ}C$ Forward Transconductance $V_{DD} = 5 \ V$, $I_D = 9.0 \ A$, $T_J = 125 \ ^{\circ}C$ Forward Transconductance $V_{DD} = 5 \ V$, $I_D = 9.0 \ A$ Input Capacitance $V_{DS} = 15 \ V$, $V_{GS} = 0 \ V$, f = 1 MHzCharacteristics $V_{DD} = 15 \ V$, $I_D = 9.0 \ A$, $V_{GS} = 10 \ V$, $R_{GEN} = 6 \ \Omega$ Turn-On Delay Time $V_{GS} = 0 \ V \ to 10 \ V$ $V_{GS} = 0 \ V \ to 4.5 \ V$ $I_D = 9.0 \ A$ Fall Time $V_{GS} = 0 \ V \ to 4.5 \ V$ $I_D = 9.0 \ A$ Total Gate Charge $V_{GS} = 0 \ V \ to 4.5 \ V$ $I_D = 9.0 \ A$ Gate to Drain "Miller" Charge $V_{GS} = 0 \ V, \ I_S = 2.0 \ A$ 	teristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}$, $I_D = 250 \ \mu$ A1.2Gate to Source Threshold Voltage $I_D = 250 \ \mu$ A, referenced to 25 °C $I_D = 250 \ \mu$ A, referenced to 25 °CStatic Drain to Source On Resistance $V_{GS} = 10 \ V, \ I_D = 9.0 \ A$ $V_{GS} = 10 \ V, \ I_D = 9.0 \ A$ Static Drain to Source On Resistance $V_{GS} = 10 \ V, \ I_D = 9.0 \ A, \ T_J = 125 \ °C$ Forward TransconductanceNumber of the transconductance $V_{DD} = 5 \ V, \ I_D = 9.0 \ A$ $V_{CS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz$ Input Capacitance $V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz$ $V_{CS} = 10 \ V, \ I_D = 9.0 \ A, \ V_{CS} = 10 \ V, \ I_D = 9.0 \ A, \ V_{CS} = 10 \ V, \ I_D = 9.0 \ A, \ V_{CS} = 10 \ V, \ I_D = 9.0 \ A, \ V_{CS} = 10 \ V, \ Reverse Transfer CapacitanceV_{DD} = 15 \ V, \ V_{CS} = 0 \ V, \ I_D = 9.0 \ A, \ V_{CS} = 10 \ V, \ Reverse \ Transfer CapacitanceCharacteristicsTurn-On Delay TimeV_{CS} = 10 \ V, \ R_{CS} = 0 \ V \ to \ 10 \ V \ V_{DD} = 15 \ V \ I_D = 9.0 \ A, \ V_{DD} = 15 \ V \ I_D = 9.0 \ A \ I_D = 9.0 $	teristicsGate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient $V_{GS} = V_{DS}$, $I_D = 250 \ \mu$ A1.21.8I_D = 250 \ \muA, referenced to 25 °C-5V_{GS} = 10 V, I_D = 9.0 A13Static Drain to Source On Resistance $V_{GS} = 10 \ V$, $I_D = 9.0 \ A$ 16V_{GS} = 10 V, I_D = 9.0 \ A, T_J = 125 °C17Forward Transconductance $V_{DD} = 5 \ V$, $I_D = 9.0 \ A$ 41haracteristicsInput Capacitance Reverse Transfer Capacitance $V_{DS} = 15 \ V$, $V_{GS} = 0 \ V$, f = 1 MHz539Output Capacitance Gate Resistance $V_{DS} = 15 \ V$, $V_{GS} = 0 \ V$, f = 1 MHz172Characteristics1.366Rise Time Filme $V_{DD} = 15 \ V$, $I_D = 9.0 \ A$, $V_{GS} = 10 \ V$, $R_{GEN} = 6 \ \Omega$ 14Fall Time Fall Time2144Total Gate Charge Gate Charge $V_{GS} = 0 \ V$ to $10 \ V$ $V_{CS} = 0 \ V$ to $4.5 \ V$ $V_{DD} = 15 \ V$ $I_D = 9.0 \ A$ 1.6Gate to Drain "Miller" Charge $V_{GS} = 0 \ V$, $I_S = 2.0 \ A$ $V_{GS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{GS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{GS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{GS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{CS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{CS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{CS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{GS} = 0 \ V$, $I_S = 100 \ A$ $V_{GS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{CS} = 0 \ V$, $I_S = 9.0 \ A$ $I_S = 9.0 \ A$ 1.6Gate Charge Gate to Drain Diode Forward Voltage $V_{GS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{GS} = 0 \ V$, $I_S = 9.0 \ A$ $V_{GS} = 0 \ V$, $I_S = 100 \ A$ 	teristics Gate to Source Threshold Voltage $V_{GS} = V_{DS}$, $I_D = 250 \ \mu$ A 1.2 1.8 3.0 Gate to Source Threshold Voltage $I_D = 250 \ \mu$ A, referenced to $25 \ ^{\circ}$ C -5 -5 Temperature Coefficient $I_D = 250 \ \mu$ A, referenced to $25 \ ^{\circ}$ C -5 -5 Static Drain to Source On Resistance $V_{GS} = 10 \ V, \ I_D = 9.0 \ A$ 13 16 Forward Transconductance $V_{DD} = 5 \ V, \ I_D = 9.0 \ A$ 11 17 21 haracteristics $V_{DD} = 5 \ V, \ I_D = 9.0 \ A$ 41 1 172 230 number Capacitance $V_{DS} = 15 \ V, \ V_{CS} = 0 \ V,$ $f = 1 \ MHz$ 24 35 Gate Resistance 1.3 16 12 13 16 Characteristics $V_{DD} = 15 \ V, \ V_{CS} = 0 \ V,$ $172 \ 230$ 24 35 Gate Resistance 1.3 1.3 1.3 1.3 1.4 Characteristics $V_{DD} = 15 \ V, \ I_D = 9.0 \ A,$ 2 10 1.4 25 Turn-Off Delay Time $V_{GS} = 0 \ V to 10 \ V$

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0 %.

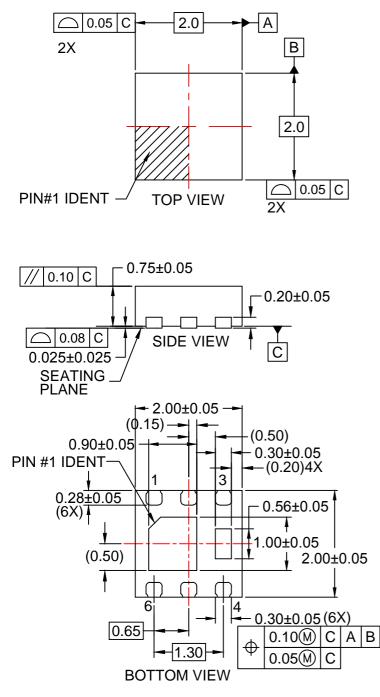
3. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

FDMA8878 Single N-Channel Power Trench[®] MOSFET



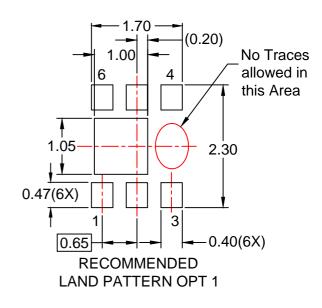


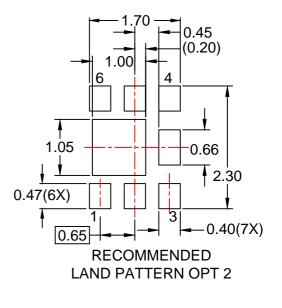
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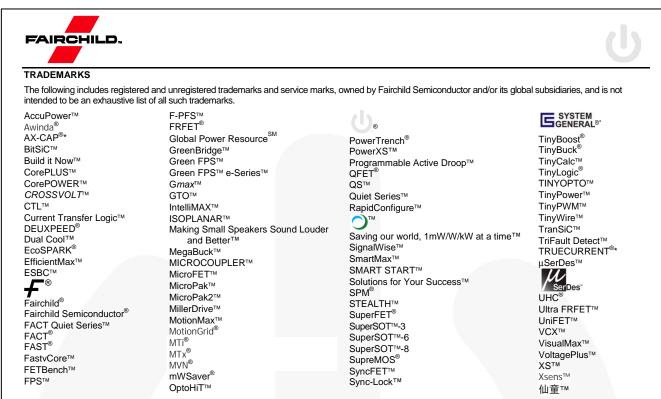
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- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
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